

SURENOO GRAPHIC OLED SERIES DISPLAY Product Specification

(Preliminary)

Part Name: OEL Display Panel SOG320132A_P383

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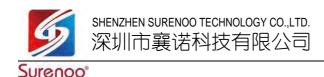
Graphic OLED Display Selection Guide

Graphic OLED Module

Graphic OLED Panel

SSD1320

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REVISION RECORD

REV.	REVISION DESCRIPTION	REV. DATE	REMARK
X01	■ INITIAL RELEASE	2018. 01. 30	
X02	 Add the information of module weight Modify the panel driving power supply Modify panel electrical specifications Modify the initial code 	2018. 06. 01	Page 5, 6, 7, 9, 11 & 12
X03	 Modify setting of 200 cd/m² Modify precautions for residual image 	2018. 08. 06	Page 12 & 46
A01	Transfer to A versionAdd polarizerAdd the packing specification	2018. 08. 09	Page 4, 5, 7, 11, 12, 25, 26 & 27
A02	 Add balloon marks for the important dimensions Add sample size table of the outgoing inspection provision 	2018. 09. 03	Page 26 & 28

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1. SCOPE

The purpose of this specification is to define the general provisions and quality requirements that apply to the supply of display cells manufactured by RiTdisplay. This document, together with the Module Assembly Drawing, is the highest-level specification for this product. It describes the product, identifies supporting documents and contains specifications.

Model No.: SOG320132A P383

2. WARRANTY

RiTdisplay warrants that the products delivered pursuant to this specification (or order) will conform to the agreed specifications for twelve (12) months from the shipping date ("Warranty Period"). RiTdisplay is obligated to repair or replace the products which are found to be defective or inconsistent with the specifications during the Warranty Period without charge, on condition that the products are stored in the original packages at 25 ℃±5 ℃, 55%±10%RH or used as the conditions specified in the specifications.

Nevertheless, RiTdisplay is not obligated to repair or replace the products without charge if the defects or inconsistency are caused by the force majeure or the reckless behaviors of the customer.

After the Warranty Period, all repairs or replacements of the products are subject to charge.

3. FEATURES

- Small molecular organic light emitting diode.
- Color: White16 gray scale
- Panel resolution: 132x320Driver IC: SSD1320 x 2
- Excellent quick response time.
- Extremely thin thickness for best mechanism design: 2.027 mm
- High contrast: 2000:1
- Wide viewing angle: 160°
- Interface: Serial Peripheral Interface
- Wide range of operating temperature : -40 to 70 ℃
- Anti-glare polarizer.

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4. MECHANICAL DATA

NO	ITEM	SPECIFICATION	UNIT
1	Dot Matrix	132 x 320	dot
2	Dot Size	0.261 (W) x 0.261 (H)	mm ²
3	Dot Pitch	0.281 (W) x 0.281 (H)	mm ²
4	Aperture Rate	86	%
5	Active Area	37.072 (W) x 89.9 (H)	mm ²
6	Panel Size	41.672 (W) x 105.52 (H)	mm ²
7*	Panel Thickness	1.82 ± 0.1	mm
8	Module Size	41.672 (W) x 145.52 (H) x 2.027 (T)	mm ³
9	Diagonal A/A size	3.83	inch
10	Module Weight	17.92 ± 10%	gram

^{*} Panel thickness includes substrate glass, cover glass and UV glue thickness.

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5. MAXIMUM RATINGS

ITEM	MIN	MAX	UNIT	Condition	Remark
Operating Temp.	-40	70	õ	-	-
Storage Temp	-40	85	℃	-	Note (2)

Note:

- (1) Maximum ratings are those values beyond which damages to the OLED module may occur. The OLED functional operation should be restricted to the limits in the section 6. Electrical Characteristics tables.
- (2) The defined temperature ranges do not include the polarizer. The maximum withstood temperature of the polarizer should be 80 ℃.

6. ELECTRICAL CHARACTERISTICS

6.1 D.C ELECTRICAL CHARACTERISTICS

SYMBOL	PARAMETER	TEST CONDITION	MIN	TYP	MAX	UNIT
V _{CC}	Operating Voltage (for OLED panel)	Ta = 25°C	12.5	-	13.5	V
V_{DD}	Digital power supply	Ta = 25°C	1.65	2.8	3.5	V
V _{OH}	Level	TUMHZ	0.9* V _{DD}	-	V_{DD}	V
V_{OL}	Low Logic Output Level	$I_{OUT} = 100uA,$ $10MHz$	0	-	0.1*V _{DD}	٧
V_{IH}	High Logic Input Level	-	0.8* V _{DD}	-	V_{DD}	٧
V_{IL}	Low Logic Input Level	-	0	-	0.2*V _{DD}	V

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6.2 ELECTRO-OPTICAL CHARACTERISTICS PANEL ELECTRICAL SPECIFICATIONS

PARAMETER	MIN	TYP.	MAX	UNITS	COMMENTS
Normal made ourrent	-	95	99	mA	All pixels on (1)
Normal mode current (ICC)	-	48	50	mA	50% pixels on (1)
(100)	-	20	21	mA	20% pixels on (1)
Standby mode current (ICC)	-	3	3.5	mA	Standby mode 10% pixels on (2)
Normal made namer	-	1235	1287	mW	All pixels on (1)
Normal mode power consumption	-	624	650	mW	50% pixels on (1)
Consumption	-	260	273	mW	20% pixels on (1)
Standby mode power consumption	-	39	45.5	mW	Standby mode 10% pixels on (2)
IDD sleep mode current	-	-	0.1	mA	Sleep mode Current (3)
ICC sleep mode current	-	-	0.1	mA	Sleep mode Current (3)
Normal Luminance	90	110	-	cd/m ²	Display Average
Standby Luminance	-	10	-	cd/m ²	
CIEx (White)	0.26	0.30	0.34		CIE1931
CIEy (White)	0.29	0.33	0.37		CIE1931
Dark Room Contrast	10000:1				
Viewing Angle	160			degree	
Response Time		10		μs	

Note:

(A) Under Vcc = 13V(B) Frame rate : 85Hz(C) Duty setting : 1/132

(1) Normal mode condition (Setting code):

```
void Initial_SSD1320(void)
{
comm_out(0xae);//Display OFF
comm_out(0xfd);//Set Command Lock
comm_out(0x12);
comm_out(0x20);//Set Memory Addressing Mode
comm_out(0x00);
comm_out(0x00);//Set Portrait Addressing Mode
comm_out(0x00);//Normal Addressing Mode
comm_out(0x81);//Set Contrast Control
comm_out(0x6b);//
```

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```
comm_out(0xa1);//Set Seg Remap
comm out(0xa2);//Set Display Start Line
comm out(0x00);
comm_out(0xa4);//Resume to RAM content display
comm out(0xa6);//Set Normal Display
comm out(0xa8);//Set MUX Ratio
comm_out(0x83);//1/132 duty
comm out(0xad);//Select external or internal IREF
comm out(0x10);
comm_out(0xbc);//Set Pre-charge voltage
comm out(0x1e);//
comm out(0xbf);//Linear LUT
comm out(0xc8);//Set COM Output Scan Direction
comm out(0xd3);//Set Display Offset
comm out(0x0e);
comm out(0xd5);//Set Display Clock Divide Ratio/Oscillator Frequency
comm out(0xc2);
comm out(0xd9);//Set Pre-charge Period
comm out(0x72);//
comm out(0xda);//Set SEG Pins Hardware Configuration
comm out(0x32);
comm out(0xbd);//Set VP
comm out(0x03);
comm out(0xdb);//Set VCOMH
comm out(0x30);
clear();// clear the whole DDRAM.
comm out(0xaf);//Display on
}
(2) Standby mode condition (Setting code):
void Initial SSD1320(void)
comm out(0xae);//Display OFF
comm out(0xfd);//Set Command Lock
comm_out(0x12);
comm out(0x20);//Set Memory Addressing Mode
comm out(0x00);
comm out(0x25);//Set Portrait Addressing Mode
```

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```
comm out(0x00);//Normal Addressing Mode
comm out(0x81);//Set Contrast Control
comm out(0x0f);
comm_out(0xa1);//Set Seg Remap
comm out(0xa2);//Set Display Start Line
comm out(0x00);
comm_out(0xa4);//Resume to RAM content display
comm out(0xa6);//Set Normal Display
comm out(0xa8);//Set MUX Ratio
comm out(0x83);//1/132 duty
comm out(0xad);//Select external or internal IREF
comm out(0x10);
comm out(0xbc);//Set Pre-charge voltage
comm out(0x1e);//
comm out(0xbf);//Linear LUT
comm out(0xc8);//Set COM Output Scan Direction
comm out(0xd3);//Set Display Offset
comm out(0x0e);
comm out(0xd5);//Set Display Clock Divide Ratio/Oscillator Frequency
comm_out(0xc2);
comm out(0xd9);//Set Pre-charge Period
comm_out(0x72);//
comm out(0xda);//Set SEG Pins Hardware Configuration
comm out(0x32);
comm out(0xde);//Set VSL
comm out(0x7a);//
comm out(0xbd);//Set VP
comm out(0x03);//
comm out(0xdb);//Set VCOMH
comm out(0x30);
clear();// clear the whole DDRAM.
comm out(0xaf);//Display on
}
```

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(3) Sleep mode condition:

When send 0xae command OLED display off and memory data will be maintained.

(4) Wake up condition:

When send 0xaf command OLED will be turned on.

Note: More setting refer to P37601 application note.

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7. LIFETIME SPECIFICATION

ITEM	MIN	UNIT	Condition	Remark
Life Time	15,000	Hrs	110 cd/m², 50% alternating checkerboard	Note (1)
Life Time	20,000	Hrs	90 cd/m², 50% alternating checkerboard	Note (2)

Note:

(A) Under Vcc = 13V(B) Frame rate : 85Hz(C) Duty setting : 1/132

(D) Life time is defined the amount of time when the luminance has decayed to less than 50% of the initial measured luminance.

```
(1) Setting of 110 cd/m<sup>2</sup>:
  void Initial SSD1320(void)
  {
  comm out(0xae);//Display OFF
  comm out(0xfd);//Set Command Lock
  comm out(0x12);
  comm out(0x20);//Set Memory Addressing Mode
  comm out(0x00);
  comm out(0x25);//Set Portrait Addressing Mode
  comm out(0x00);//Normal Addressing Mode
  comm out(0x81);//Set Contrast Control
  comm out(0x6b);//
  comm out(0xa1);//Set Seg Remap
  comm_out(0xa2);//Set Display Start Line
  comm out(0x00);
  comm out(0xa4);//Resume to RAM content display
  comm_out(0xa6);//Set Normal Display
  comm out(0xa8);//Set MUX Ratio
  comm out(0x83);//1/132 duty
  comm_out(0xad);//Select external or internal IREF
  comm out(0x10);
  comm out(0xbc);//Set Pre-charge voltage
  comm_out(0x1e);//
```

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```
comm out(0xbf);//Linear LUT
  comm out(0xc8);//Set COM Output Scan Direction
  comm out(0xd3);//Set Display Offset
  comm_out(0x0e);
  comm out(0xd5);//Set Display Clock Divide Ratio/Oscillator Frequency
  comm out(0xc2);
  comm_out(0xd9);//Set Pre-charge Period
  comm out(0x72);//
  comm out(0xda);//Set SEG Pins Hardware Configuration
  comm out(0x32);
  comm out(0xbd);//Set VP
  comm out(0x03);
  comm out(0xdb);//Set VCOMH
  comm out(0x30);
  clear();// clear the whole DDRAM.
  comm out(0xaf);//Display on
  }
(2) Setting of 90 cd/m<sup>2</sup>:
  void Initial SSD1320(void)
  comm out(0xae);//Display OFF
  comm out(0xfd);//Set Command Lock
  comm out(0x12);
  comm out(0x20);//Set Memory Addressing Mode
  comm out(0x00);
  comm out(0x25);//Set Portrait Addressing Mode
  comm out(0x00);//Normal Addressing Mode
  comm out(0x81);//Set Contrast Control
  comm out(0x54);//
  comm out(0xa1);//Set Seg Remap
  comm out(0xa2);//Set Display Start Line
  comm out(0x00);
  comm out(0xa4);//Resume to RAM content display
  comm out(0xa6);//Set Normal Display
  comm out(0xa8);//Set MUX Ratio
  comm out(0x83);//1/132 duty
  comm out(0xad);//Select external or internal IREF
```

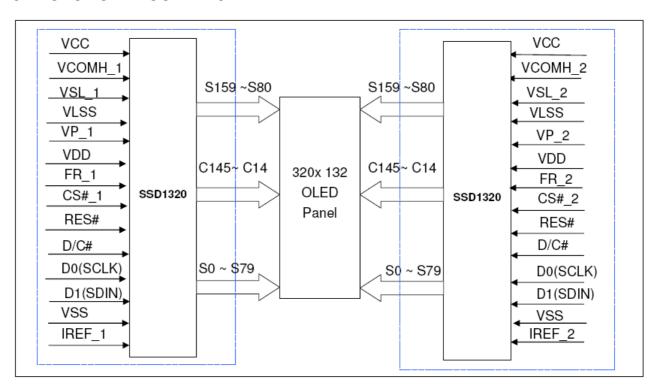
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```
comm_out(0x10);
comm_out(0xbc);//Set Pre-charge voltage
comm out(0x1e);//
comm_out(0xbf);//Linear LUT
comm out(0xc8);//Set COM Output Scan Direction
comm out(0xd3);//Set Display Offset
comm_out(0x0e);
comm_out(0xd5);//Set Display Clock Divide Ratio/Oscillator Frequency
comm out(0xc2);
comm_out(0xd9);//Set Pre-charge Period
comm_out(0x72);//
comm out(0xda);//Set SEG Pins Hardware Configuration
comm out(0x32);
comm out(0xbd);//Set VP
comm out(0x03);
comm out(0xdb);//Set VCOMH
comm out(0x30);
clear();// clear the whole DDRAM.
comm out(0xaf);//Display on
}
```

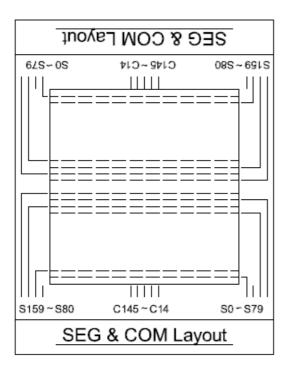
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8. INTERFACE

8.1 FUNCTION BLOCK DIAGRAM



8.2 PANEL LAYOUT DIAGRAM



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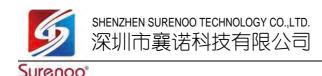


8.3 PIN ASSIGNMENTS

FPC_1

Pin No	Pin Name	Description
1	vcc	Power supply for panel driving voltage.
2	VCOMH_1	COM signal deselected voltage level.
3	VSL_1	This is segment voltage (output low level) reference pin.
4	VLSS	Analog system ground pin.
5	VP_1	This pin is the segment pre-charge voltage reference pin. Power supply pin for core logic operation.
6	VDD	Power supply pin for core logic operation.
7	FR_1	This pin outputs RAM write synchronization signal.
8	CS#_1	This pin is the chip select input connecting to the MCU. (active LOW)
9	RES#	This pin is reset signal input.
10	D/C#	This pin is Data/Command control pin connecting to the MCU.
11	D0(SCLK)	The serial clock input: SCLK.
12	D1(SDIN)	The serial data input: SDIN.
13	VSS	Ground pin.
14	VLSS	Analog system ground pin.
15	IREF_1	This pin is the segment output current reference pin.
16	vcc	Power supply for panel driving voltage.

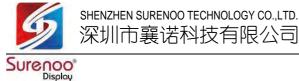
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FPC_2

Pin No	Pin Name	Description
1	VCC	Power supply for panel driving voltage.
2	VCOMH_2	COM signal deselected voltage level.
3	VSL_2	This is segment voltage (output low level) reference pin.
4	VLSS	Analog system ground pin.
5	VP_2	This pin is the segment pre-charge voltage reference pin.
6	VDD	Power supply pin for core logic operation.
7	FR_2	This pin outputs RAM write synchronization signal.
8	CS#_2	This pin is the chip select input connecting to the MCU. (active LOW)
9	RES#	This pin is reset signal input.
10	D/C#	This pin is Data/Command control pin connecting to the MCU.
11	D0(SCLK)	The serial clock input: SCLK.
12	D1(SDIN)	The serial data input: SDIN.
13	VSS	Ground pin.
14	VLSS	Analog system ground pin.
15	IREF_2	This pin is the segment output current reference pin.
16	VCC	Power supply for panel driving voltage.

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8.4 GRAPHIC DISPLAY DATA RAM ADDRESS MAP

The GDDRAM is a bit mapped static RAM holding the bit pattern to be displayed. The size of the RAM is 160x160x4 bits. For mechanical flexibility, re-mapping on both Segment and Common outputs can be selected by software. The GDDRAM address maps in Table show some examples to re-map the GDDRAM. In the following tables, the lower nibble and higher nibble of D0, D1, D2 ... D12797, D12798,D12799 represent the 160x160 data bytes in the GDDRAM.

These are the commands for Re-map setting:

Description	Type	Register
Disable/Enable Column Address Re-map	Single Byte	A0h/A1h
Horizontal/Vertical Address Increment	Double Byte	20h 00h/01h
Disable/Enable COM Re-map	Single Byte	C0h/C8h
Disable/Enable Portrait Mode	Double Byte	25h 00h/01h

Table shows the GDDRAM map under the following condition:

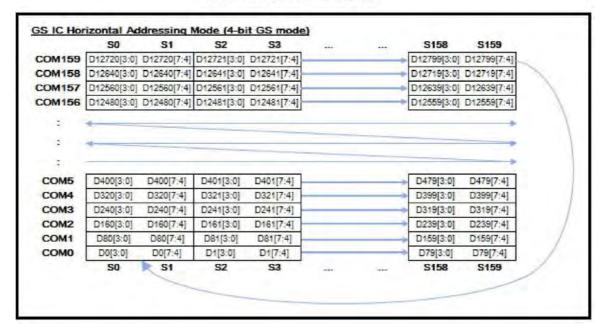
Command Setting:

Disable Column Address Re-map
Horizontal Address Increment
Disable COM Re-map
Disable Portrait Mode

A0h
20h 00h
C0h
25h 00h

- Display Start Line=00h
- Data byte sequence: D0, D1, D2 ... D12799

Table: GDDRAM address map 1



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Table shows the GDDRAM map under the following condition:

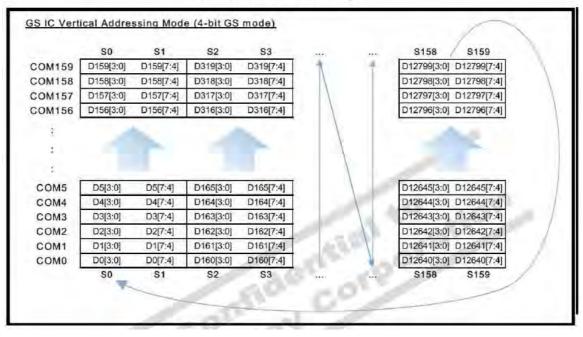
Command Setting:

Disable Column Address Re-map A0h Vertical Address Increment 20h 01h Disable COM Re-map C0h Disable Portrait Mode 25h 00h

Display Start Line=00h

• Data byte sequence: D0, D1, D2 ... D12799

Table: GDDRAM address map 2



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Table shows the GDDRAM map under the following condition:

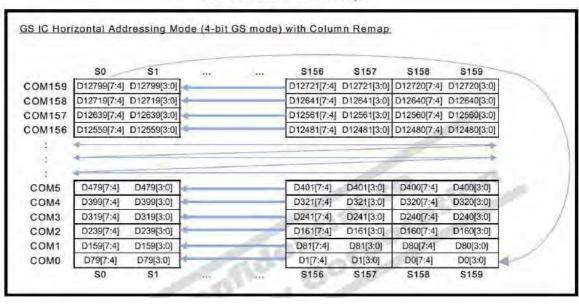
Command Setting:

Enable Column Address Re-map
Horizontal Address Increment
Disable COM Re-map
Coh
Disable Portrait Mode
20h 00h
C0h
25h 00h

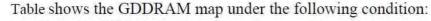
Display Start Line=00h

• Data byte sequence: D0, D1, D2 ... D12799

Table: GDDRAM address map 3



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Command Setting:

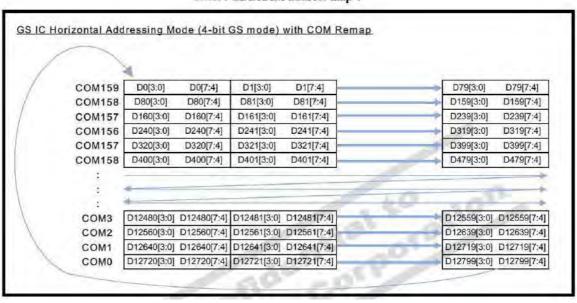
Disable Column Address Re-map
Horizontal Address Increment
Enable COM Re-map
C8h

Disable Portrait Mode 25h 00h

• Display Start Line=00h

• Data byte sequence: D0, D1, D2 ... D12799

Table: GDDRAM address map 4



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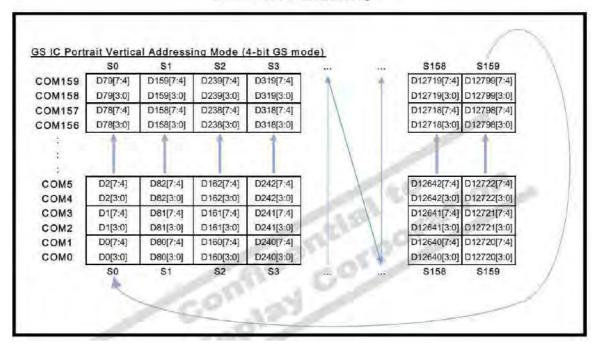
Table shows the GDDRAM map under the following condition:

Command Setting:

Disable Column Address Re-map A0h Vertical Address Increment 20h 01h Disable COM Re-map C0h Enable Portrait Mode 25h 01h

- Display Start Line=00h
- Data byte sequence: D0, D1, D2 ... D12799

Table: GDDRAM address map 5



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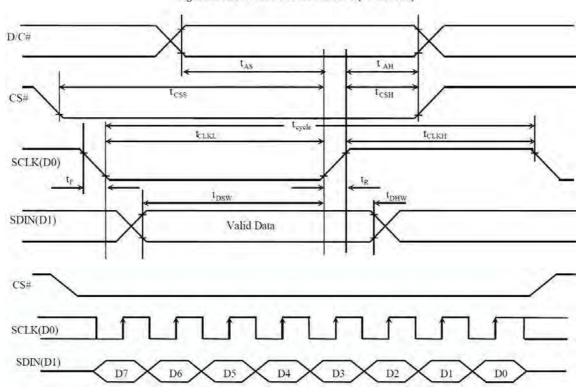
8.5 INTERFACE TIMING CHART

Table Serial Interface Timing Characteristics (4-wire SPI)

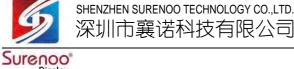
 $(V_{DD} - V_{SS} = 1.65 V_{\sim} 3.5 V, T_A = 25 {\circ} C)$

Symbol	Parameter	Min	Typ	Max	Unit
tcycle	Clock Cycle Time	66		perto.	ns
tas	Address Setup Time	15	1.0		ns
t _{AH}	Address Hold Time	15		2	ns
tess	Chip Select Setup Time	20	+	-	ns
tcsH	Chip Select Hold Time	10	18	9:00	ns
tosw	Write Data Setup Time	15	4		ns
tohw	Write Data Hold Time	15	-		ns
tclkl	Clock Low Time	20	. ·		ns
tclkh	Clock High Time	20	i.e.		ns
t _R	Rise Time	120	4	15	ns
$t_{\rm F}$	Fall Time	19		15	ns

Figure Serial interface characteristics (4-wire SPI)



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9. POWER ON / OFF SEQUENCE & APPLICATION CIRCUIT

9.1 POWER ON / OFF SEQUENCE

The following figures illustrate the recommended power ON and power OFF sequence of SSD1320 (SPD1320).

Power ON sequence:

- 1. Power ON V_{DD}
- 2. After V_{DD} become stable, wait at least 20ms (t_0), set RES# pin LOW (logic low) for at least 3us (t_1) ⁽⁴⁾ and then HIGH (logic high).
- 3. After set RES# pin LOW (logic low), wait for at least 3us (t₂). Then Power ON V_{CC}. (1)
- 4. After V_{CC} become stable, send command AFh for display ON. SEG/COM will be ON after 200ms(t_{AF}).

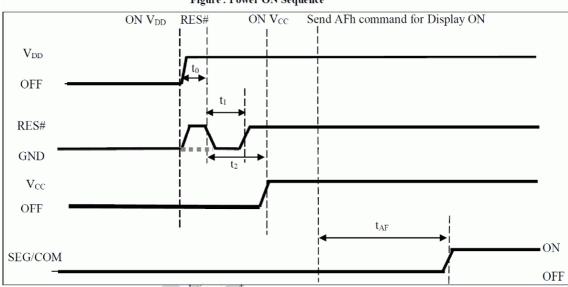
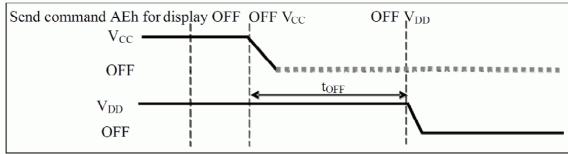


Figure: Power ON Sequence

Power OFF sequence:

- 1. Send command AEh for display OFF.
- 2. Power OFF V_{CC}. (1), (2)
- 3. Power OFF V_{DD} after t_{OFF}. (4) (where Minimum t_{OFF}=80ms, typical t_{OFF}=100ms) Figure: Power OFF Sequence

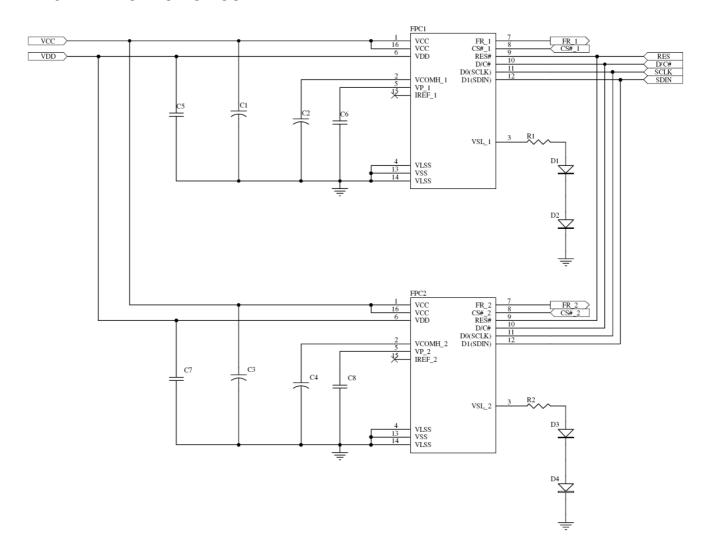


Note

- (1) V_{CC} should be kept float (i.e. disable) when it is OFF.
- (2) Power Pins (V_{DD}, V_{CC}) can never be pulled to ground under any circumstance.
- (3) The register values are reset after t₁.
- (4) V_{DD} should not be Power OFF before V_{CC} Power OFF.

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9.2 APPLICATION CIRCUIT



Recommend components:

C1, C2, C3, C4: 4.7uF/25V (Tantalum type) or VISHAY (572D475X0025A2T)

C5, C6, C7, C8: 1uF/16V R1, R2: 49.9 ohm 1/4W

D1, D2, D3, D4: RB480K (ROHM)

9.3 COMMAND TABLE

Refer to IC Spec.: SSD1320

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10. RELIABILITY TEST CONDITIONS

No.	Items	Specification	Quantity
1	High temp. (Non-operation)	85℃, 240hrs	5
2	High temp. (Operation)	70℃, 120hrs	5
3	Low temp. (Operation)	-40℃, 120hrs	5
4	High temp. / High humidity (Operation)	65℃, 90%RH, 120hrs	5
5	Thermal shock (Non-operation)	-40 °C ~85 °C (-40 °C /30min; transit /3min; 85 °C /30min; transit /3min) 1cycle: 66min, 100 cycles	5
6	Vibration	Frequency: 5~50HZ, 0.5G Scan rate: 1 oct/min Time: 2 hrs/axis Test axis: X, Y, Z	1 Carton
7	Drop	Height: 120cm Sequence : 1 angle \ 3 edges and 6 faces Cycles: 1	1 Carton
8	ESD (Non-operation)	Air discharge model, ±8kV, 10 times	5

Test and measurement conditions

- 1. All measurements shall not be started until the specimens attain to temperature stability.
- 2. The degradation of Polarizer are ignored for item 1, 4 & 5.

Evaluation criteria

- 1. The function test is OK.
- 2. No observable defects.
- 3. Luminance: > 50% of initial value.
- 4. Current consumption: within \pm 50% of initial value.

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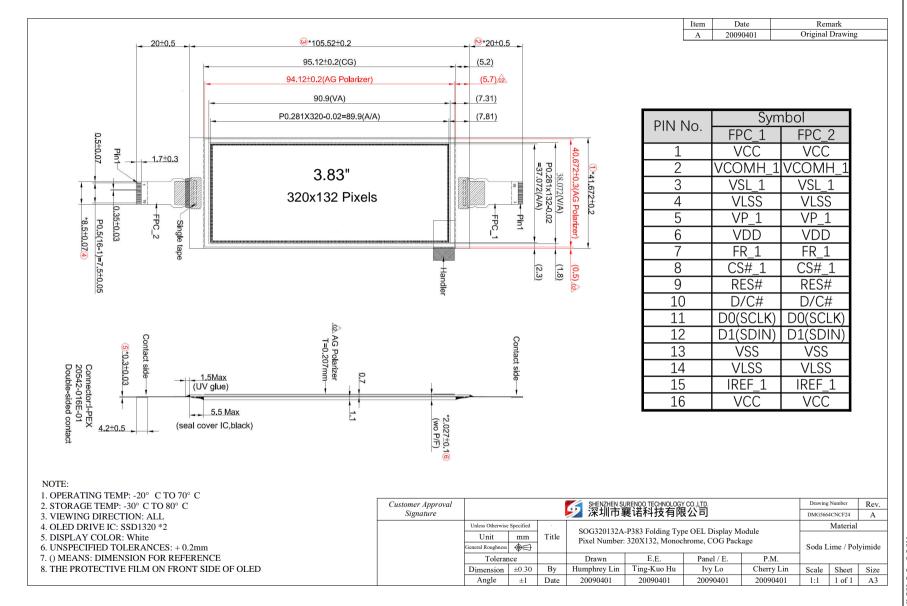
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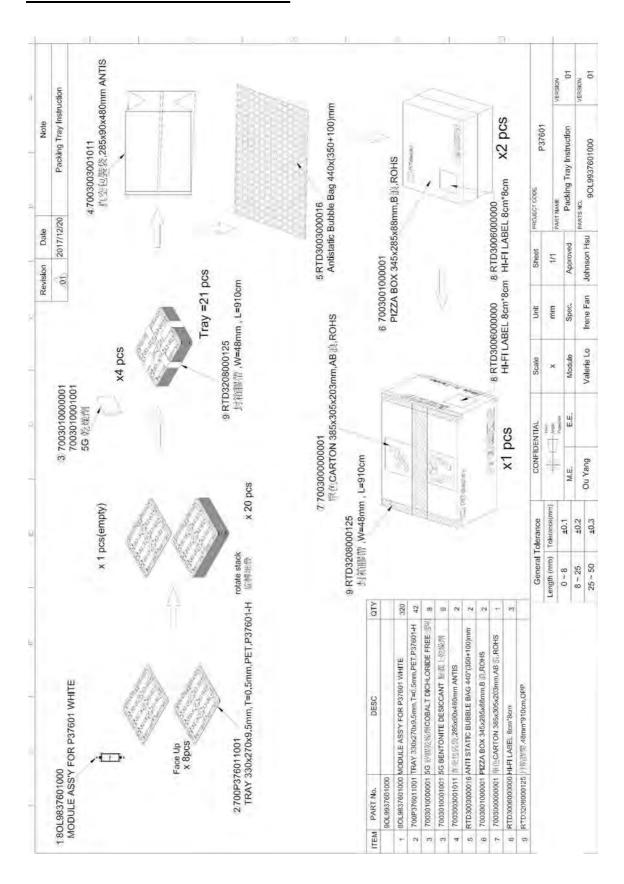


DIMENSION

EXTERNAL



12. PACKING SPECIFICATION



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13. OUTGOING INSPECTION PROVISION

1. 抽樣方法 / SAMPLING METHOD

(1) MIL-STD-1916 / 驗證水準 level III / 正常檢驗 / 單次樣品檢驗 MIL-STD-1916 / inspection level III / normal inspection / single sample inspection

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(2) 主要缺陷 Level III; 次要缺陷 Level II Major Level III; Minor Level II

		MIL-ST	D-1916	樣本代字	2對照表			
##=	驗證水準(VL)							
批量	VII	VI	V	IV	Ш	П	I	
2~170	Α	Α	Α	Α	A	Α	A	
$171 \sim 288$	Α	Α	Α	Α	Α	Α	В	
289 ~ 544	Α	Α	Α	Α	Α	В	C	
545~960	A	Α	Α	Α	В	С	D	
961 ~ 1632	Α	Α	Α	В	C	D	Е	
$1633 \sim 3072$	Α	Α	В	C	D	E	E	
3073 ~ 5440	Α	В	С	D	Е	E	Е	
5441 ~ 9216	В	С	D	Е	Е	Е	Е	
9217 ~ 17408	C	D	E	E	Е	E	E	
$17409 \sim 30720$	D	E	E	Е	Е	Е	Е	
≥ 30721	Е	Е	Е	E	E	E	Е	

檬 本		驗證水準(VL)							
代字	Т	VII	VI	V	IV	Ш	П	1	
(CL)	樣本大小								
A	3072	1280	512	192	80	32	12	5	
В	4096	1536	640	256	96	40	16	6	
С	5120	2048	768	320	128	48	20	8	
D	6144	2560	1024	384	160	64	24	10	
E	8192	3072	1280	512	192	80	32	12	

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2. 檢驗條件 / INSPECTION CONDITION

檢查和測量在下列條件下進行的,除非另有規定。

The inspection and meaurement are performed under the following conditions, unless otherwise specified.

溫度 / Temperature: 25±5℃ 濕度 / Humidity: 50±10%R.H.

壓力 / Pressure: 860~1060hPa (mbar)

檢驗員拿的面板和眼睛之間的距離 / Distance between the panel and

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eyes of the inspector≥30cm

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3. 品質檢驗規格 / SPECIFICATION FOR QUALITY CHECK

3.1缺陷分類 / DEFECT CLASSIFICATION

嚴重度	檢驗項目	缺陷	備註
Severity	Inspection Item	Defect	Remark
主要缺陷	1. 面板	(1) 無顯示	
Major	Panel	Non-displaying	
Defect		(2) 線缺陷	
		Line defects	
		(3) 故障	
		Malfunction	
		(4) 玻璃破損	
		Glass cracked	
	2. 軟板	(1) 軟板尺寸超規	不能組裝
	Film	Film dimension out of	Can not be
		specification	assembled
	3. 尺寸	(1) 外形尺寸超規	
	Dimension	Outline dimension out	
分面知识力	1 宏振	of specification	
次要缺陷 Minor	1. 面板 Panel	(1) 玻璃刮傷 Glass scratch	
Defect	Fallel	(2) 玻璃切割異常	
Defect		Glass cutting NG	
		(3) 玻璃崩邊、崩角	
		Glass chip	
	2. 偏光板	(1) 偏光板刮傷	
	Polarizer	Polarizer scratch	
		(2) 表面汙漬	外觀缺陷
		Stains on surface	Appearance
		(3) 偏光板氣泡	defect
		Polarizer bubbles	doroot
	3. 顯示	(1) 暗點、亮點、髒污	
	Displaying	Dim spot Bright spot dust	
	4. 軟板	(1) 損傷	
	Film	Damage	
		(2) 異物	
		Foreign material	

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3.2 出貨規格 / OUTGOING SPECIFICATION

	Q R R P O O I GOING		1
項目	描述	標準	允收
Item	Description	Criterion	水準 AQL
I. 面板	1 . 玻璃刮傷		次要
Panel Glass scratch		寬 / Width 長 / Length 容許個數 (mm) umber of W L pieces permitted	Minor
		W≤0.03 忽略 忽略 Ignore Ignore	
		0.03< W≤0.05 L≤1 1	
		0.05< W 無 None	
		顯示區外 2mm 2mm 2mm 2mm 2mm 1gnore	
	2. 玻璃破損 Glass crack	(1) 裂紋 / Crack 擴展裂紋是不能接受的。 Propagation crack is not acceptable.	主要 Major
	3. 玻璃崩邊、崩角 Glass chip	(1) 崩角 / Chip on corner	次要 Minor
		(2) 崩邊 / Chip on edge	

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	_							
項目	描述	標準 Criterion						
Item	Description		水準 AQL					
I. 面板	3. 玻璃崩邊、崩角						次要	
Panel	Glass chip	崩角	Size	崩邊	Size		Minor	
		Chip on	(mm)	Chip on	(mm			
		corner		edge				
		X	≦1.5	X	≦3.0			
		Y	≦2.0	Υ	≦1.0)		
		Z	≦t	Z	≦t			
		はまた / Note	. .					
		備註 / Note						
		1.t = 玻璃/ t = glass						
		t = glass thickness 2. 崩邊或崩角延伸到 ITO 導線是不能接受的。						
				extending in		-		
		contact						
	4. 尺寸	請參閱圖紙	主要					
	Dimension	Refer to the drawing of the spec						
Ⅱ. 偏光板	1.刮傷	點狀按照"項目 II-3 偏光板氣泡"的標準。						
Polarizer	Scratch	Spot type in accordance with the criteria of						
			I-3. Polarizer bubble". 照"項目 I-1 玻璃刮傷"的標準。					
		Line type in "Item I-1. G						
	2. 表面汙漬	表面汙漬無法用軟布或類似的清潔物輕輕擦拭						
	Stains on	去除。						
	surface	Stains cannot be removed even when wiped						
		lightly with						
	3. 偏光板氣泡	(mm)					次要	
	Polarizer]]	尺寸	容許個			Minor	
	bubble		Size	number				
				pieces per				
			Þ≦0.2	忽略 Japan				
		02/0	Φ≦0.5	lgnore 2	D			
		0.5<0		0				
			→ 示區外	 忽略				
		beyond A.A. Ign re						
		L	OHU A.A.	igii it	C			

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					允收		
項目	描述	標準			水準		
Item	Description		Criter	ion	AQL		
Ⅲ. 顯示	1. 耗電	該模	該模組的工作電流消耗不應超出產品規格書的				
Displaying	Power	規範	規範。				
	consumption	The	The module operating current consumption				
			should not go beyond the standard indicated				
			in Product Specification				
	2. 像素尺寸		顯示像素的尺寸的公差應規格的 ±25 %之內。				
	Pixel size		tolerance of display	•	Minor		
			ıld be within ±25% c	of specification.			
	3. 顏色		產品規格。		主要		
	Color		er to the product spe	cification.	Major		
	4. 亮度		產品規格。		主要		
	Luminance		er to the product spe	cification.	Major 次要		
	5. 暗點、亮點 、	1.	1.				
	髒污		平均直徑	容許個數	Minor		
	Dimming		Average diameter	number of			
	spot · Lighting		D:(mm) D ≤0.1	pieces permitted 忽略			
	spot · Dust		D <u>≦</u> 0.1	Ignore			
			0.1 < D ≦0.15	1			
			0.15< D ≦0.2	1			
			$0.15 < D \ge 0.2$ 0.2 < D	0			
			·				
			顯示區外	忽略			
			beyond A.A.	Ignore			
		D=(長邊直徑 + 短邊直徑)/2					
		D=(long diameter + short diameter)/2					
	像素暗點是不允許。						
		Pixel off is not allowed.					

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項目 Item	描述 Description	標準 Criterion					
III. 顯示 Displaying	5. 暗點、亮點 、 髒污 Dimming spot、Lighting spot、Dust	2.	長 length(mm) L 忽略 Ignore L≦1	容許個數 number of pieces permitted 忽略 Ignore 3 無 None 忽略 Ignore	次要 Minor		
IV. 軟板 Film	1. 尺寸 Dimension	軟板尺寸超規。 Film dimension out of Spec.					
	2. 損傷 Damage	破損;深刮傷;沒 不能接受的。 Crack; deep scra pressure mark or acceptable.	; deep	Major 次要 Minor			
	3. 異物 Foreign material	導電異物附著在導線,軟板和玻璃之間的異物是不能接受的。 Conductive foreign material sticking to the leads, foreign material between film and glass are not acceptable.					

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14. APPENDIXES

APPENDIX 1: DEFINITIONS

A. DEFINITION OF CHROMATICITY COORDINATE

The chromaticity coordinate is defined as the coordinate value on the CIE 1931 color chart for R, G, B, W.

B. DEFINITION OF CONTRAST RATIO

The contrast ratio is defined as the following formula:

C. DEFINITION OF RESPONSE TIME

The definition of turn-on response time Tr is the time interval between a pixel reaching 10% of steady state luminance and 90% of steady state luminance. The definition of turn-off response time Tf is the time interval between a pixel reaching 90% of steady state luminance and 10% of steady state luminance. It is shown in Figure 2.

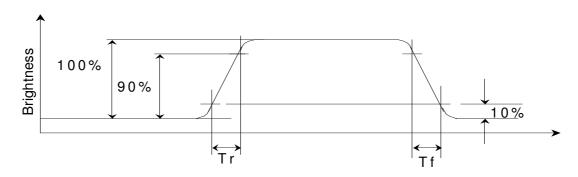


Figure 2 Response time

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D. DEFINITION OF VIEWING ANGLE

The viewing angle is defined as Figure 3. Horizontal and vertical (H & V) angles are determined for viewing directions where luminance varies by 50% of the perpendicular value.

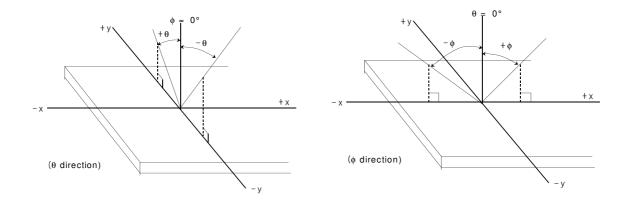


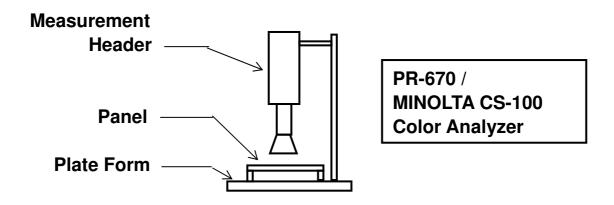
Figure 3 Viewing angle

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APPENDIX 2: MEASUREMENT APPARATUS

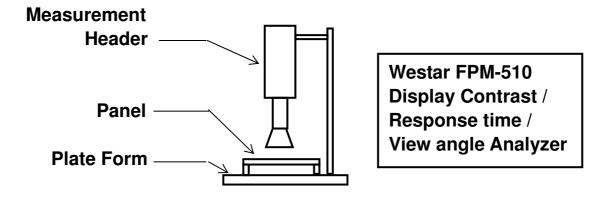
A. LUMINANCE/COLOR COORDINATE

PHOTO RESEARCH PR-670, MINOLTA CS-100



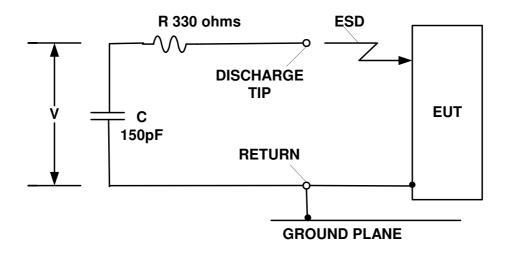
B. CONTRAST / RESPONSE TIME / VIEWING ANGLE

WESTAR CORPORATION FPM-510



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C. ESD ON AIR DISCHARGE MODE



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APPENDIX 3: PRECAUTIONS FOR USING THE OLED MODULE

Precautions for Handling

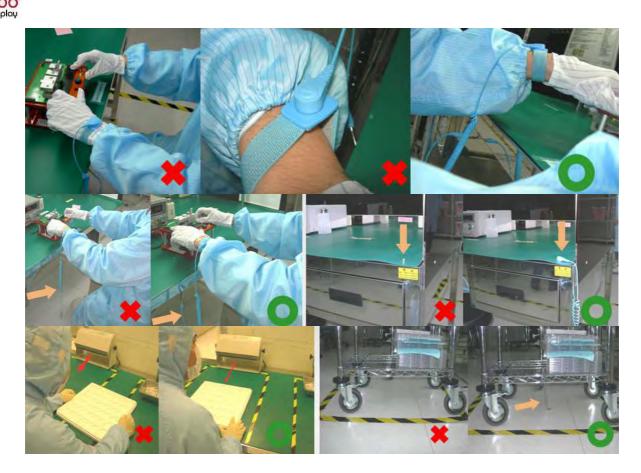
1. When handling the module, wear powder-free anti static rubber finger cots/ anti-static clothing, anti-static gloves, antistatic wrist strap and anti-static shoes

The environment should dispose the static elimination blower, anti-static pad, anti-static chair, and anti-static floor. The humidity maintains usually more than 40%

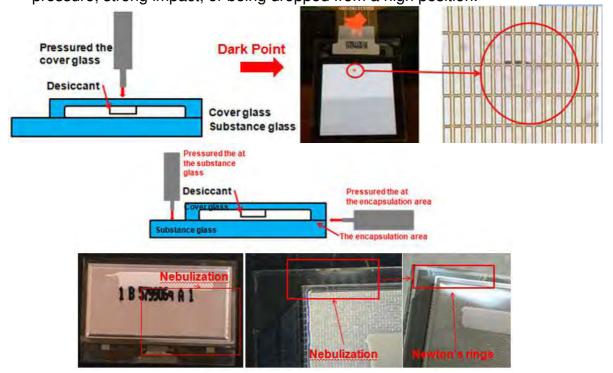


2. The OLED module is an electronic component and is subject to damage caused by Electro Static Discharge (ESD). And hence normal ESD precautions must be taken when handling it. Also, appropriate ESD protective environment must be administered and maintained in the production line. When handling and assembling the panel, wear an antistatic wrist strap with the alligator clip attached to the ground to prevent ESD damage on the panel. Antistatic wrist strap should touch human body directly instead of gloves. (See below photos).

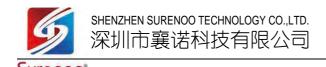
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3. The OLED module is consisted of glass and film, and it should avoid pressure, strong impact, or being dropped from a high position.



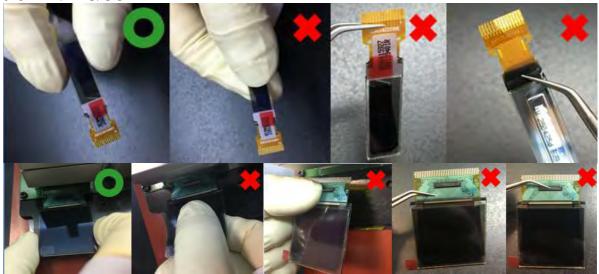
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4. Take out the panel one by one from the holding trays for assembly, and never put the panel on top of another one to avoid the scratch.



- 5. Avoid jerk and excessive bend on TAB/FPC/COF, and be careful not to let foreign matter or bezel damage the film.
- 6. When handling and assembling the module (panel + IC), grab the panel, not the TAB/FPC/COF.



7. Use the tweezers to open the clicks on the connector of PCB before the insertion of FPC/COF, and click them back in. Once the FPC/COF sits properly in the connector, use the tweezers to avoid the damages.

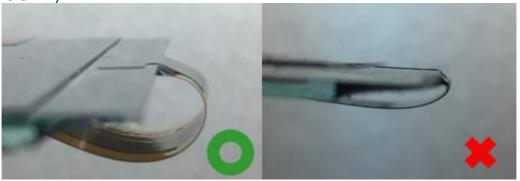




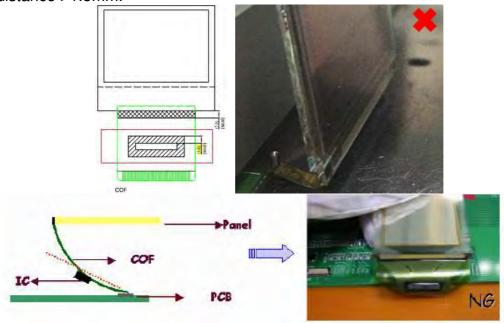


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8. Please do not bend the film near the substrate glass. It could cause film peeling and TAB/FPC/COF damage. For TAB, It should bend the slit area as actual OLED it is. For FPC or COF, it is suggested to follow below pictures for instruction (distance between substrate glass and bending area >1.5mm; R>0.5mm).



9. Avoid bending the film at IC bonding area. It could damage the IC ILB bonding. It should avoid bending the IC seal area. Please keep the bending distance >1.5mm.



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Use finger to insert COF /FPC into the connector when assembling the panel. Please refer to the photo.



COF: Use both thumbs

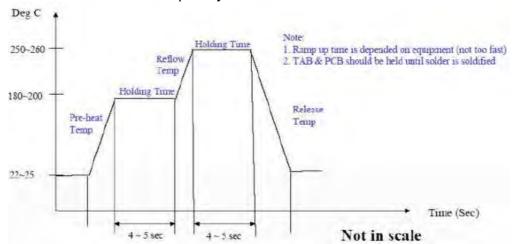


- 10. Do not wipe the pin of film and polarizer with the dry or hard materials that will damage the surface. When cleaning the display surface, use the soft cloth with solvent, IPA or alcohol, to clean.
- 11. Protection film is applied to the surface of OLED panel to avoid the scratch. Please remove the protective film before assembling it. If the OLED panel has been stored for a long time, the residue adhesive material of the protective film may remain on the display surface after remove the protective film. Please use the soft cloth with solvent, IPA or alcohol, to clean.
- 12. When hand or hot-bar soldering TAB/FPC onto PCB, make sure the temperature and timing profiles to meet the requirements of soldering specification (the specification depends on the application or optimized by customer) to prevent the damage of IC pins by inappropriate soldering, and also avoid the high temperature to damage the Organic light-emitting materials.



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- 13. Solder residues arise from soldering process have to be cleaned up thoroughly before the module assembly.
- 14. Use the voltage and current settings listed in the specification to do the function test after the module assembly.
- 15. Suggestion for soldering process:
 - i. TAB Lead- free soldering hot bar process
 - 1. Use pulse heated bonding tool equipment
 - 2. Material: Sn/Ag/Cu lead-free solder paste with typical 25um thickness on PCB pad. The TAB pin size and shape may be different, please base on the production line to adjust the thickness of PCB pad and temperature.S
 - 3. Bonding Force:--4kg per centimeter square as the starting point.
 - 4. Suggested bonding tool temperature & time profile is as below for reference. Since there are differences in TAB soldering pins, soldering technicians' skills, mechanism...etc., the soldering conditions must be adequately tuned.



- ii. TAB Lead- free soldering wire process In case of manual soldering (Lead- free solder wire)
 - 1. Solder wire contact iron directly: 280±5 °C at 3-5secs
 - 2. Solder wire contact TAB lead directly (near iron but not contact): 380±5 °C. 3-5secs
 - 3. Since there are differences in TAB soldering pins, soldering technicians' skills, mechanism...etc., the soldering conditions must be adequately tuned.
- iii. High temperature will result in rapid heat conduction to IC and might cause damage to IC, so please keep the temperature below 380 °C. Also, avoid damaging the polyimide and solder resist which might take place at high temperatures. Refold cycles base on the de-soldering status, if the plating of pin was damaged, it can not be used again.

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Precautions for Electrical

1. Design using the settings in the specification

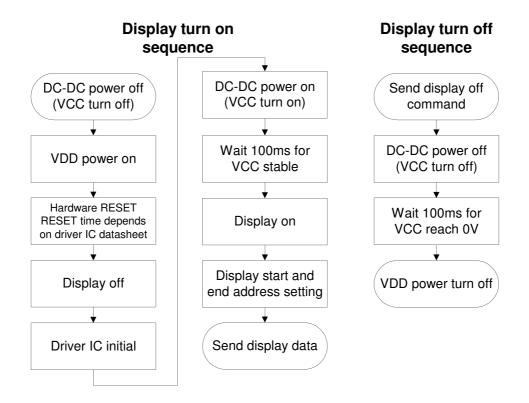
It is very important to design and operate the panel using the settings listed in the specification. It includes voltage, current, frame rate and duty cycle... etc. Operation the OLED outside the range of the specification should be entirely avoided to ensure proper operation of the OLED.

2. Maximum Ratings

To ensure the proper operation of the panel, never design the panel with parameters running over the maximum ratings listed in the specification. Also the logic voltages such as VIL and VIH have to be within the specified range in the specification to prevent any improper operation of the panel.

3. Power on/off procedure

To avoid any inadvertent effects resulting from inappropriate power on/off operations, please follow the directions of power on/off procedure on page 6. Any operation that does not comply with the procedure could cause permanent damage of the IC and should be avoided. When the logic power is not on, do not activate any input signal. Abrupt shutdown of power to the module, while the OLED panel is on, would cause OLED panel malfunction.

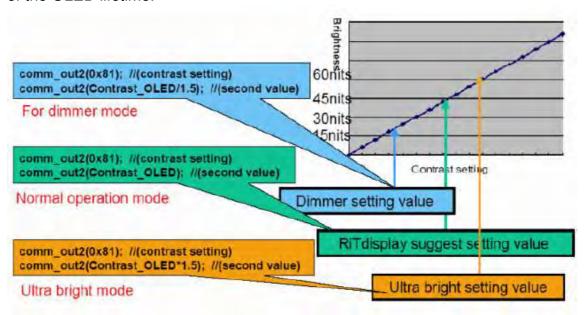


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4. Power savings

To save power consumption of the OLED, please use partial display or sleep mode when the panel is not fully activated. Also, if possible, make the black background to save power.

The OLED is a self-luminous device and a particular pixel cluster or image can be lit on via software control. So power savings can be achieved by partial display or dimming down the luminance. Depending on the application, the user can choose among Ultra Bright Mode, Normal Operation Mode, and Sleeping Mode. The power consumption is almost in directly proportion to the brightness of the panel, and also in directly proportion to the number of pixels lit on the panel. The customer can save the power by the use of black background and sleeping mode. One benefit from using these design schemes is the extension of the OLED lifetime.



5. Adjusting the luminance of the panel

Although there are a couple of ways to adjust the luminance of the panel, it is strongly recommended that the customer change the contrast setting to adjust the luminance of the panel. Adjusting voltages to achieve desired luminance is not allowed. Be aware that the adjustment of luminance would accompany the change of lifetime of the panel and its power consumption as well.

6. Residual Image (Image Sticking)

The OLED is a self-emissive device. As with other self-emissive device or displays consisting of self-emissive pixels, when a static image frozen for a long period of time is changed to another one with all-pixels-on background, residual image or image sticking is noticed by the human eye. Image sticking is due to the luminance difference or contrast between the pixels that were previously turned on and the pixels that are newly turned on. Image sticking depends on the luminance decay curve of the display. The slower the decay, the less prominent the image sticking is. It is strongly recommended that the user employ the following four strategies to minimize image sticking.

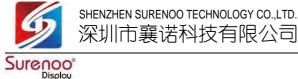
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- 1. <u>Employ image scrolling or animation</u> to even out the lit-on time of each and every pixel on the display, also could use sleeping mode for reduced the residual image and extend the power capacity.
- 2. <u>Minimize the use of all-pixels-on or full white background</u> in their application because when the panel is turned on full white, the image sticking from previously shown patterns is the most revealing. Black background is the best for power savings, greatest visibility, eye appealing, and dazzling displays.
- 3. Avoid displaying the characters or menu with high brightness level in a fix position for a long time or repeatedly. If necessary, using the auto fadeout technology.
- 4. If a static logo is used in the reliability test, change the pattern into its inverse (i.e., turn off the while pixels and turn on the previously unlit pixels) and freeze the inverse pattern as long as the original logo is used, so every pixel on the panel can be lit on for about the same time to minimize image sticking, caused by the differential turn-on time between the original and its reverse patterns.





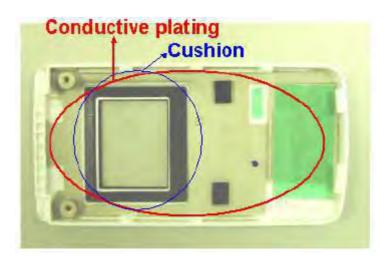
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Precautions for Mechanical

1. Cushion or Buffer tape on the cover glass

It is strongly recommended to have a cushion or buffer tape to apply on the panel backside and front side when assembling OLED panel into module to protect it from damage due to excessive extraneous forces.



It is recommended that a plating conductive layer be used in the housing for EMI/EMC protection. And, the enough space should be reserved for the IC placement if the IC thickness is thicker than the TAB film when customer design the PCB.

2. Avoid excessive bending of film when handling or designing the panel into the product

The bending of TAB/COF/FPC has to follow the precautions indicated in the specification, extra bending or excessive extraneous forces should be avoided to minimize the chances of film damage. If bending the film is necessary, please bend the designated bending area only. Please refer to items 8 and 9 of Precautions for Handling for more information.

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Precautions for Storage and Reliability Test

1. Storage

Store the packed cartons or packages at 25 ℃±5 ℃, 55%±10%RH. Do not store the OLED module under direct sunlight or UV light. For best panel performance, unpack the cartons and start the production of the panels within six months after the reception of them.

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2. Reliability Test

RiTdisplay only guarantees the reliability of the OLEDs under the test conditions and durations listed in the specification.

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